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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









PTC thermistors for motor starting

Metallized disks for low power consumption

Series/Type: B595**

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Low power consumption

Applications

■ Time delay in turning off the auxiliary winding of single-phase AC motors

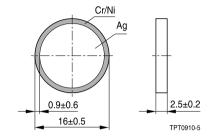
Features

- Metallization: CrNi (sputtered) + Ag (screen-printed)
- Excellent long-term reliability
- Suitable for clamp contacting
- For approvals see table below
- RoHS-compatible

Delivery mode

■ Bulk

Dimensional drawing



General technical data

Switching cycles		N	> 100000	
Operating temperature range	(V = 0)	T _{op}	+5/+80	°C
Operating temperature range	$(V = V_{max})$	T _{op}	+5/+80	°C

Electrical specifications and ordering codes

Туре	I _{max}	V_{max}	T_{ref}	t _S ¹⁾	$V_{BD}^{2)}$	$R_R \pm \Delta R_R$	Ordering code
			(typ.)			$(V_{PTC} \le 2.5 \text{ V})$	
	Α	V	°C	s	V	Ω	
$V_{R} = 120$) V _{RMS}						
A546	12	180	135	0.45	> 360	4.70 ±20%	B59546A0135A020
A548	12	200	135	0.30	> 400	6.80 ±20%	B59548A0135A020
$V_R = 230 V_{RMS}$							
A551	5	400	135	0.25	> 710	47 ±20%	B59551A0135A020
A549	8	350	135	0.30	> 640	22 ±20%	B59549A0135A020
A550	8	355	135	0.25	> 700	33 ±20%	B59550A0135A020
A556	8	350	135	0.35	> 600	15 ±20%	B59556A0135A020

¹⁾ Measured at V = V_{max} and I = $0.8 \cdot I_{max}$

²⁾ PTC clamped between crown contacts (diameter: 2 mm).



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Approvals

Туре	UL	IECQ	VDE
A546	Χ	Χ	Χ
A548	Χ	_	_
A549	Χ	_	-
A550	Х	Х	Х
A551	Χ	-	_
A556	Χ	Χ	Χ

UL approval to UL 1434 (file number E69802)

IECQ certified in accordance with IEC 60738-1 (certificate number 101-QA-5)

VDE approval (certificate number 87406)

Reliability data

Test ¹⁾	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, V _{max} ; I _{max}	< 25%
cycling		Number of cycles: 100 000	
Electrical endurance,	IEC 60738-1	Storage at V_{max} and $T_{op,max}$ (@ V_{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 20%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$	< 20%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 \text{ V})$	< 25%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 \text{ V})$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	

¹⁾ For testing all PTC thermistor disks are equiped with an EPCOS housing.



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 1210 and smaller: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Gloves are recommended
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force and pressure of the clamping contacts pressing against the PTC must be 10 N and 50 kPa, respectively. In case the assembly is exposed to mechanical shock and/ or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

Display of ordering codes for EPCOS products

The ordering code for one and the same EPCOS product can be represented differently in data sheets, data books, other publications, on the EPCOS website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes



Low power consumption

Symbols and terms

Symbol	Term
A	Area
С	Capacitance
C_{th}	Heat capacity
f	Frequency
1	Current
I _{max}	Maximum current
I_{R}	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
I_r	Residual currrent
$I_{r,oil}$	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
Is	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
N_c	Operating cycles at V _{max} , charging of capacitor
N_{f}	Switching cycles at V _{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P_{el}	Electrical power
P_{diss}	Dissipation power
R_{G}	Generator internal resistance
R_{min}	Minimum resistance
R_R	Rated resistance @ rated temperature T _R
ΔR_R	Tolerance of R _R
R_P	Parallel resistance
R_{PTC}	PTC resistance
R_{ref}	Reference resistance
R_s	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅



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Т	Temperature
t	Time
T_A	Ambient temperature
ta	Thermal threshold time
T _C	Ferroelectric Curie temperature
t _E	Settling time (for level sensors)
T_R	Rated temperature @ 25 °C or otherwise specified in the data sheet
T_{sense}	Sensing temperature
T_{op}	Operating temperature
T_{PTC}	PTC temperature
t_R	Response time
T_{ref}	Reference temperature
T_{Rmin}	Temperature at minimum resistance
ts	Switching time
T_{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
$V_{c(max)}$	Maximum DC charge voltage of the surge generator
$V_{F,max}$	Maximum voltage applied at fault conditions in protection mode
V_{RMS}	Root-mean-square value of voltage
V_{BD}	Breakdown voltage
V_{ins}	Insulation test voltage
$V_{link,max}$	Maximum link voltage
V_{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V_{meas}	Measuring voltage
$V_{meas,max}$	Maximum measuring voltage
V_R	Rated voltage
V_{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
τ_{th}	Thermal cooling time constant

λ

е

Failure rate

Lead spacing (in mm)



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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Important notes

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